



austriamicrosystems AG

is now

ams AG

The technical content of this austriamicrosystems datasheet is still valid.

Contact information:

Headquarters:

ams AG
Tobelbaderstrasse 30
8141 Unterpremstaetten, Austria

Tel: +43 (0) 3136 500 0

e-Mail: ams_sales@ams.com

Please visit our website at www.ams.com



AS1113

50mA, 16-Channel LED Driver with Diagnostics

1 General Description

The AS1113 is designed to drive up to 16 LEDs through a fast serial interface and features 16 output constant current drivers and an on-chip diagnostic read-back function.

The high clock-frequency (up to 50MHz), adjustable output current, and flexible serial interface makes the device perfectly suited for high-volume transmission applications.

Output current is adjustable (up to 50mA/channel) using an external resistor (REXT).

The serial interface with Schmitt trigger inputs includes an integrated shift register. Additionally, an internal data register stores the currently displayed data.

The device features integrated diagnostics for over-temperature, open-LED, and shorted-LED conditions. Integrated registers store global fault status information during load as well as the detailed temperature/open-LED/shorted-LED diagnostics results.

The AS1113 also features a low-current diagnostic mode to minimize display flicker during fault testing.

The AS1113 is available in a 24-pin SSOP and the 28-pin QFN (5x5mm) package.

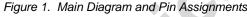
If a higher output current is needed, please see the AS1110 with 100mA drive capability.

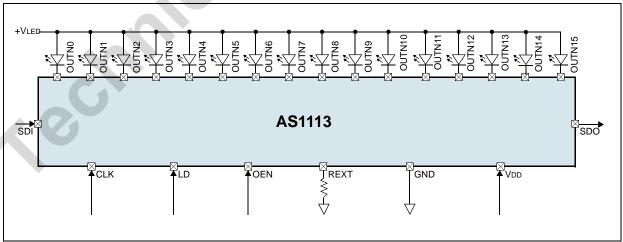
2 Key Features

- 16 Constant-Current Output Channels
- Excellent Output Current Accuracy
- Between Channels: <±3%
- Between Devices: <±6%
- Output Current Per Channel: 0.5 to 50mA
- Controlled In-Rush Current
- Over-Temperature, Open-LED, Shorted-LED Diagnostic Functions
- Low-Current Test Mode
- Global Fault Monitoring
- Low Shutdown Mode Current: 10µA
- Fast Serial Interface: 50MHz
- Cascaded Configuration
- Extremely Fast Output Drivers Suitable for PWM
- 24-pin SSOP and 28-pin QFN (5x5mm) Package

3 Applications

The device is ideal for fixed- or slow-rolling displays using static or multiplexed LED matrix and dimming functions, large LED matrix displays, mixed LED display and switch monitoring, displays in elevators, public transports (underground, trains, buses, taxis, airplanes, etc.), large displays in stadiums and public areas, price indicators in retail stores, promotional panels, bar-graph displays, industrial controller displays, white good panels, emergency light indicators, and traffic signs.







Contents

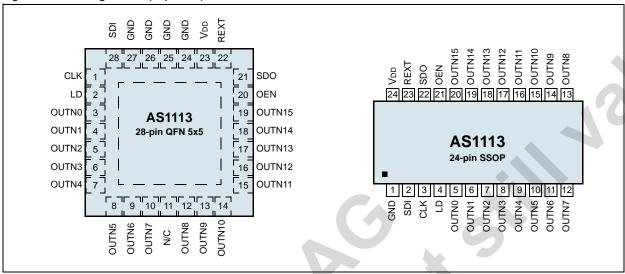
	General Description	
2	Key Features	1
3	Applications	1
4	Pinout	3
	Pin Assignments	3
	Pin Descriptions	
5	Absolute Maximum Ratings	2
	Electrical Characteristics	
-	Switching Characteristics	
7	Typical Operating Characteristics	
	Detailed Description	
Ü	Serial Interface	
	Timing Diagrams	
	Error-Detection Mode	
	Global Error Mode	
	Error Detection Functions	
	Open-LED Detection	
	Shorted-LED	
	Overtemperature	
	Detailed Error Reports	
	Detailed Temperature Warning Report	. 13
	Detailed Open-LED Error Report	. 14
	Detailed Shorted-LED Error Report	
	Low-Current Diagnostic Mode	
	Shutdown Mode	
9	Application Information	17
	Error Detection	
	Error Detection On-The-Fly	
	Error Detection with Low-Current Diagnosis Mode	
	Cascading Devices	
	Constant Current	
	Adjusting Output Current	
	Package Power Dissipation	
	Delayed Outputs	
	Switching-Noise Reduction	
	Load Supply Voltage	
	Package Drawings and Markings	
11	Ordering Information	23



4 Pinout

Pin Assignments

Figure 2. Pin Assignments (Top View)



Pin Descriptions

Table 1. Pin Descriptions

Pin Number		D' M	
SSOP	QFN	Pin Name	Description
1	24:27	GND	Ground
2	28	SDI	Serial Data Input
3	1	CLK	Serial Data Clock . The rising edge of the CLK signal is used to clock data into and out of the AS1113 shift register. In error mode, the rising edge of the CLK signal is used to switch error modes.
4	2	LD	Serial Data Load
5:20 3:10 OUTN0:15 sense for diagnostic m		OUTN0:15	Output Current Drivers . These pins are used as LED drivers or for input sense for diagnostic modes. Data is transferred to the data register at the rising edge of these pins.
21	20	OEN	Output Enable. The active-low pin OEN signal can always enable output drivers to sink current independent of the AS1113 mode. 0 = Output drivers are enabled. 1 = Output drivers are disabled.
22	21	SDO	Serial Data Output. In normal mode SDO is latched out 8.5 clock cycles after SDI is latched in. In global error detection mode this pin indicates the occurrence of a global error. 0 = Global error mode returned an error. 1 = No errors.
23	22	REXT	External Resistor Connection . This pin connects through the external resistor (REXT) to GND, to setup the load current.
24	23	VDD	Positive Supply Voltage
-	11	N/C	Not connected



5 Absolute Maximum Ratings

Stresses beyond those listed in Table 2 may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in Section 6 Electrical Characteristics on page 5 is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Table 2. Absolute Maximum Ratings

Parameter		Min	Max	Units	Comments
VDD to C	VDD to GND		7	V	
Input Vol	Itage	-0.4	VDD +0.4	V	.0
Output Vo	oltage	-0.4	15	V	1.0
GND Pin C	Current		1000	mA	
Thermal Resis	etanaa (A.IA		88	°C/W	on PCB, 24-pin SSOP package
memai Resis	Starice GJA		23	°C/W	on PCB, 28-pin QFN (5x5mm) package
Ambient Tem	perature	-40	+85	°C	
Storage Tem	perature	-55	150	°C	
Humid	lity	5	86	%	Non-condensing
Electrostatic	Digital Outputs	2 2		kV	Norm: MIL 833 E method 3015
Discharge	All Other Pins				Norm: MIL 833 E method 3015
Latch-Up In	nmunity	-100 - (INOM x 0.5)	+100 + INOM	mA	EIA/JESD78
Package Body Temperature			+260	°C	The reflow peak soldering temperature (body temperature) specified is in accordance with IPC/JEDEC J-STD-020D "Moisture/Reflow Sensitivity Classification for Non-Hermetic Solid State Surface Mount Devices". The lead finish for Pb-free leaded packages is matte tin (100% Sn).



6 Electrical Characteristics

Table 3. Electrical Characteristics

Symbol	Parameter		Condition	Min	Тур	Max	Unit	
VDD	Sup	ply Voltage		3.0		5.5	V	
VDS	Output Voltage		OUTN0:15	0		15.0	V	
lout			OUTN0:15	0.5		50		
Іон	Out	out Current	SDO	-1.0			mA	
lol			SDO	1.0				
VIH	Input Voltage	High Level	CLK, OEN, LD, SDI	0.7 x VDD		VDD+ 0.3	V	
VIL	iliput voltage	Low Level	CLK, OEN, ED, SDI	-0.3		0.3 x VDD	V	
IDS(OFF)	Output L	eakage Current	OEN = 1, VDS = 15.0V			0.5	μΑ	
Vol	Output		IoL = +1.0mA	33		0.4		
Vон	Voltage	SDO	IOH = -1.0mA	V _{DD} - 0.4V			V	
IAV(LC1)	Device-to-De Current from	vice Average Output OUTN0 to OUTN15	$VDS = 0.5V, VDD = Const., \\ REXT = 744\Omega$		25.25		mA	
ΔIAV(LC1)		rrent Skew een Channels)	$\label{eq:VDS} \begin{aligned} \text{Vds} & \geq 0.5 \text{V, Vdd} = \text{Const.,} \\ \text{Rext} & = 744 \Omega \end{aligned}$		±1.5	±3	%	
IAV(LC2)	Device-to-Device Average Output Current from OUTN0 to OUTN15		$\begin{aligned} \text{VDS} &= 0.6\text{V}, \text{VDD} > 3.3\text{V}, \\ \text{REXT} &= 372\Omega \end{aligned}$		50.5		mA	
ΔIAV(LC2)	Current Skew (Between Channels)		$\label{eq:VDS} \begin{aligned} \text{VdS} \geq 0.6 \text{V, Vdd} = \text{Const.,} \\ \text{Rext} = 372 \Omega \end{aligned}$		±1.5	±3	%	
ILC	Low-Current Diagnosis Mode		VDS = 0.8V, VDD = 5.0V	0.4	0.6	0.8	mA	
IPD	Power Dov	vn Supply Current	$VDS = 0.8V, VDD = 5.0V,$ REXT = 372 Ω , OUTN0:15 = On		10	20	μA	
%/ΔVDS		nt Current vs. oltage Regulation	Vps within 1.0 and 3.0V		±0.1		%/V	
%/∆Vdd		nt Current vs. oltage Regulation	VDD within 3.0 and 5.0V		±1		%/V	
RIN(UP)	Pullup	Resistance	OEN	250	500	800	kΩ	
RIN(DOWN)	Pulldov	vn Resistance	LD	250	500	800	kΩ	
VTHL	Error Detection	on Threshold Voltage		0.25	0.3	0.45	V	
Vтнн	Error Detection	on Threshold Voltage	VDD = 3.0V	1.2	1.3	1.4	V	
V 11 II 1	LITOI Beleett	on Threshold Voltage	VDD = 5.0V	2.0	2.2	2.4]	
Tov1	Overtemperature Threshold Flag		3		150		۰C	
IDD(OFF)0	U		REXT = Open, OUTN0:15 = Off		2.7	6		
IDD(OFF)1	Comments :	Off	Rext = 744Ω , OUTN0:15 = Off		4.3	8		
IDD(OFF)2	Supply Current		Rext = 372Ω , OUTN0:15 = Off		5.4	9	mA	
IDD(ON)1		On	Rext = 744Ω , OUTN0:15 = On		6.2	11		
IDD(ON)2)	Rext = 372Ω , OUTN0:15 = On		10.5	15		



Switching Characteristics

VDD = 3.0 to 5.5V, VDS = 0.8V, VIH = VDD, VIL = GND, REXT = 372Ω , VLOAD = 4.0V, RLOAD = 64Ω , CLOAD = 10pF; guaranteed by design.

Table 4. Switching Characteristics for VDD = 5V

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
tP1	D D T (A.V.)	CLK - SDO		5	10	
tP2	Propagation Delay Time (Without Staggered Output Delay)	LD - OUTNn		100	200	ns
tP3	Olaggered Output Belay)	OEN - OUTN <i>n</i>		100	200	
tP4	Propagation Delay Time				10	ns
tW(CLK)		CLK	15			
tW(L)	Pulse Width	LD	15			ns
tW(OE)		OEN (@Iout < 60mA)	200			
tr *	CLK Rise Time				500	ns
tF *	CLK Fall Time				500	ns
tor	Output Rise Time of Vout (Turn Off)			100	200	ns
tOF	Output Fall Time of Vo∪⊤ (Turn On)			100	300	ns
tsu(D)	Setup Time for SDI		5			ns
tH(D)	Hold Time for SDI		5			ns
tSU(L)	Setup Time for LD		5			ns
tH(L)	Hold Time for LD		5			ns
ttesting	OEN Time for Error Detection		2000			ns
tstag	Staggered Output Delay			20	40	ns
tSU(OE)	Output Enable Setup Time		20			ns
tGSW(ERROR)	Global Error Switching Setup Time		10			ns
tsu(error)	Global Error Detection Setup Time		10			ns
tP(I/O)	Propagation Delay Global Error Flag				5	ns
tsw(error)	Switching Time Global Error Flag				10	ns
fclk	Maximum Clock Frequency (Cascade Operation)		30	50		MHz
t P3,ON	Low-Current Test Mode	Turn ON		3	5	μs
t _{P3,OFF}	Propagation Delay Time	Turn OFF		0.05	0.1	μs
tREXT2,1	External Resistor Reaction Time	Change from REXT1 = 372Ω , louT1 = 50.52 mA to REXT2 = 37.2 k Ω , louT2 < 1mA		0.5	1	μs
tREXT2,1	External Resistor Reaction Time	Change from REXT1 = $37.2k\Omega$, IOUT1 = 0.5 mA to REXT2 = 372Ω , IOUT2 > 25 mA		0.5	1	μs

^{*} If multiple AS1113 devices are cascaded and tr or tr is large, it may be critical to achieve the timing required for data transfer between two cascaded LED drivers.



7 Typical Operating Characteristics

Figure 3. Output Current vs. REXT, VDD = 5V; VDS = 0.8V, TAMB = 25°C

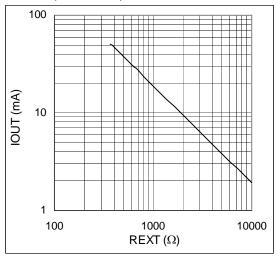


Figure 5. Output Current vs. VDS; VDD = 5V, TAMB = 25°C

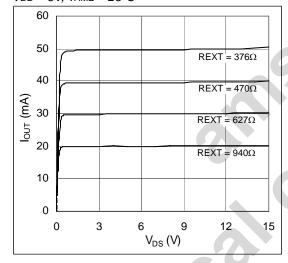


Figure 4. Relative Output Current Error vs. VDD, Iout/Iout@VDD=5V - 1, TAMB = 25°C

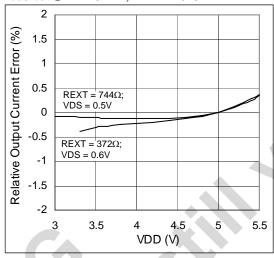
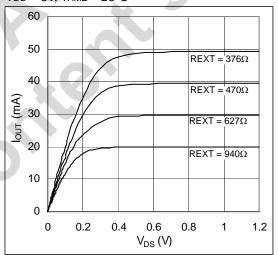


Figure 6. Output Current vs. VDS; VDD = 5V, TAMB = 25°C





8 Detailed Description

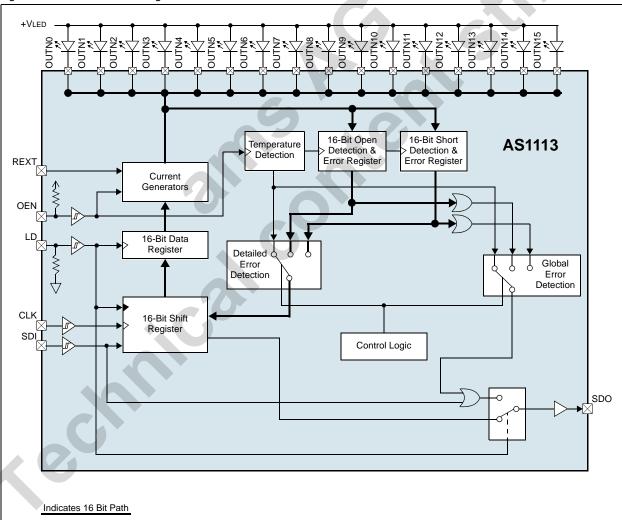
The AS1113 is designed to drive up to 16 LEDs through a fast serial interface and 16 constant-current output drivers. Furthermore, the AS1113 provides diagnostics for detecting open- or shorted-LEDs, as well as over-temperature conditions for LED display systems, especially LED traffic sign applications.

The AS1113 contains an 16-bit shift register and an 16-bit data register, which convert serial input data into parallel output format. At AS1113 output stages, sixteen regulated current sinks are designed to provide uniform and constant current with excellent matching between ports for driving LEDs within a wide range of forward voltage variations. External output current is adjustable from 0.5 to 50mA using an external resistor for flexibility in controlling the brightness intensity of LEDs. The AS1113 guarantees to endure 15V maximum at the outputs.

The serial interface is capable of operating at a minimum of 30 MHz, satisfying the requirements of high-volume data transmission.

Using a multiplexed input/output technique, the AS1113 adds additional functionality to pins SDO, LD and OEN. These pins provide highly useful functions (open- and shorted-LED detection, over-temperature detection), thus reducing pin count. Over-temperature detection will work on-the-run, whereas the open- and shorted-LED detection can be used on-the-run or in low-current diagnostic mode (see page 15).

Figure 7. AS1113 - Block Diagram





Serial Interface

Data accesses are made serially via pins SDI and SDO. At each CLK rising edge, the signal present at pin SDI is shifted into the first bit of the internal shift register and the other bits are shifted ahead of the first bit. The MSB is the first bit to be clocked in. In error-detection mode the shift register will latch-in the corresponding error data of temperature-, open-, and short-error register with each falling edge of LD.

The 16-bit data register will latch the data of the shift register at each rising edge of LD. This data is then used to drive the current generator output drivers to switch on the corresponding LEDs as OEN goes low.

Timing Diagrams

This section contains timing diagrams referenced in other sections of this data sheet.

Figure 8. Normal Mode Timing Diagram

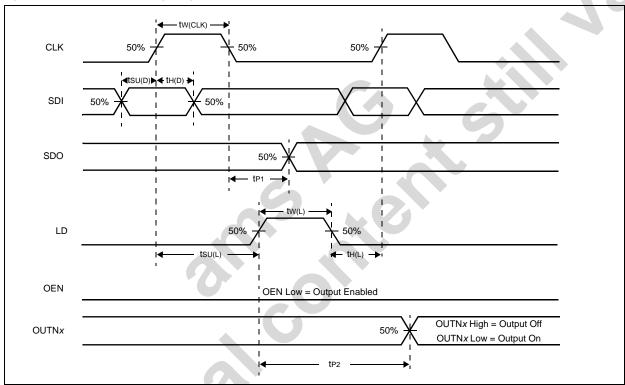


Figure 9. Output Delay Timing Diagram

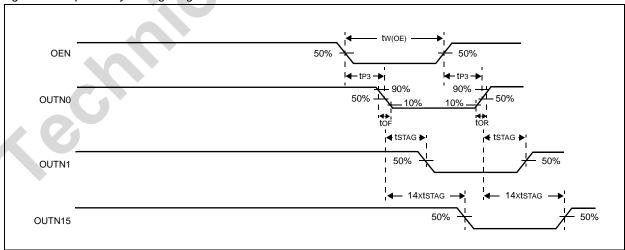




Figure 10. Data Input Timing Diagram

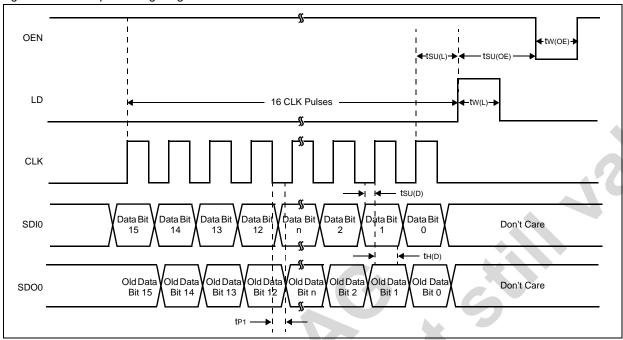
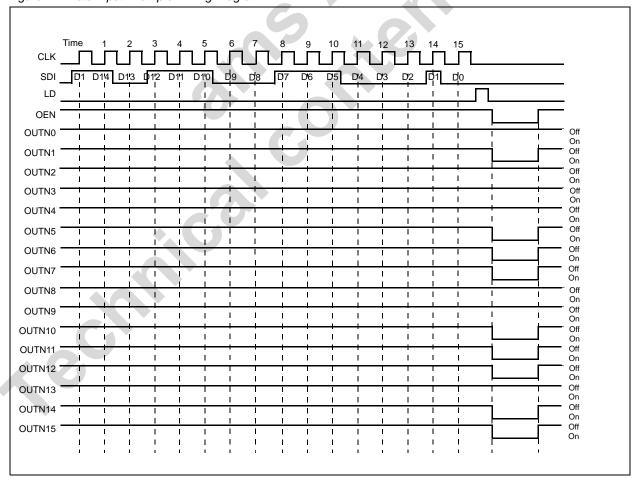


Figure 11. Data Input Example Timing Diagram





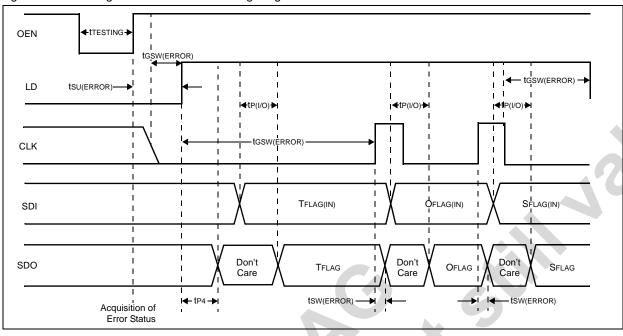


Figure 12. Switching Global Error Mode Timing Diagram

Error-Detection Mode

Acquisition of the error status occurs at the rising edge of OEN. Error-detection mode is started on the rising edge of LD when OEN is high. The CLK signal must be low when entering error detection mode. Error detection for open- and shorted-LEDs can only be performed for LEDs that are switched on during test time. To switch between error-detection modes clock pulses are needed (see Table 5).

Note: To test all LEDs, a test pattern that turns on all LEDs must be input to the AS1113.

Global Error Mode

Global error mode is entered when error-detection mode is started. Clock pulses during this period are used to select between temperature, open-LED, and shorted-LED tests, as well as low-current diagnostic mode and shutdown mode (see Table 5). In global error mode, an error flag (TFLAG, OFLAG, SFLAG) is delivered to pin SDO if any errors are encountered.

Table 5. Global Error Mode Selections

Clock Pulses	Output Port	Error-Detection Mode	Global Error Flag/Shutdown Condition
0	Don't Care	Over-Temperature	TFLAG = SDO = 1: No over-temperature warning.
	Bont Garo	Detection	TFLAG = SDO = 0: Over-temperature warning.
4		Enabled Open-LED Detection	OFLAG = SDO = 1: No open-LED error.
1	Enabled		OFLAG = SDO = 0: Open-LED error.
2	Enabled	Enabled Shorted-LED Detection	SFLAG = SDO = 1: No shorted-LED error.
2			SFLAG = SDO = 0: Shorted-LED error.
3	Don't Care	Low-Current Diagnostic Mode	
4	Don't Care	Don't Care Shutdown Mode	SDI = 1: Wakeup
4	Don't Cale	Shalaowh Mode	SDI = 0: Shutdown

Note: For a valid result SDI must be 1 for the first device.



If there are multiple AS1113s in a chain, the error flag will be gated through all devices. To get a valid result at the end of the chain, a logic 1 must be applied to the SDI input of the first device of the chain. If one device produces an error this error will show up after $n^*tP(I/O) + tSW(ERROR)$ at pin SDO of the last device in the chain. This means it is not possible to identify which device in the chain produced the error. Therefore, if a global error occurs, the detailed error report can be run to identify which AS1113, or LED produced the error.

Note: When no error has occurred, the detailed error report can be skipped, setting LD and subsequently OEN low.

Error Detection Functions

Open-LED Detection

The AS1113 open-LED detection is based on the comparison between VDS and VTHL. The open LED status is aquired at the rising edge of OEN and stored internally. While detecting open-LEDs the output port must be turned on. Open LED detection can be started with 1 clock pulse during error detection mode while the output port is turned on.

Note: LEDs which are turned off at test time cannot be tested and will be shown as a logic 1 in the detailed error report.

Table 6. Open LED Detection Modes

Output Port State	Effective Output Point Conditions	Detected Open-LED Error Status Code	Meaning
On	VDS < VTHL	0	Open Circuit
On	VDS > VTHL	1	Normal

Shorted-LED

The AS1113 shorted-LED detection is based on the comparison between VDS and VTHH. The shortened LED status is aquired at the rising edge of OEN and stored internally. While detecting shorted-LEDs the output port must be turned on. Shorted-LED detection can be started with 2 clock pulses during error detection mode while the output port is turned on.

For valid results, the voltage at OUTN0:OUTN15 must be lower then VTHH under low-current diagnostic mode operating conditions. This can be achieved by reducing the VLED voltage or by adding additional diodes, resistors or LED's.

Note: LEDs which are turned off at test time cannot be tested and will be shown as a logic 1 in the detailed error report.

Table 7. Shorted LED Detection Modes

Output Port State	Effective Output Point Conditions	Detected Shorted-LED Error Status Code	Meaning
On	VDS > VTHH	0	Short Circuit
On	VDS < VTHH	1	Normal

Overtemperature

Thermal protection for the AS1113 is provided by continuously monitoring the device's core temperature. The overtemperature status is aquired at the rising edge of OEN and stored internally.

Table 8. Overtemperature Modes

Output Port State	Effective Output Point Conditions	Detected Overtemperature Status Code	Meaning
Don't Care	Temperature > Tov1	0	Overtemperature Condition
Don't Care	Temperature < Tov1	1	Normal



Detailed Error Reports

The detailed error report can be read out after global error mode has been run. At the falling edge of LD, the detailed error report of the selected test is latched into the shift register and can be clocked out with n*16 clock cycles (n is the number of AS1113s in a chain) via pin SDO. At the same time new data can be written into the shift register, which is loaded on the next rising edge of pin LD. This pattern is shown at the output drivers, at the falling edge of OEN.

Detailed Temperature Warning Report

The detailed temperature warning report can be read out immediately after global error mode has been run. SDI must be 1 for the first device. Bit0 of the 16bit data word represents the temperature flag of the chip.

Detailed Error Report Readout Global Flag Readout OEN LD t(SU)ERROR CLK Don't SDI Care New Data Input Don't **TFLAG** SDO Undefined Care Temperature Error Report Output For detailed timing information see Timing Diagrams on page 9.

Figure 13. Detailed Temperature Warning Report Timing Diagram

Detailed Temperature Warning Report Example

Consider a case where four AS1113s are cascaded in one chain. The detailed error report lists the temperatures for each device in the chain:

In this case, IC3 is overheated and will generate a global error, and therefore 4*16 clock cycles are needed to write out the detailed temperature warning report, and optionally read in new data. The detailed temperature warning report would look like this:

The 0 in the detailed temperature warning report indicates that IC3 is the device with the over-temperature condition.

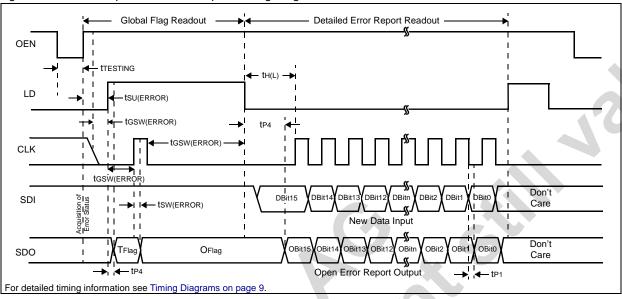
Note: In an actual report there are no spaces in the output.



Detailed Open-LED Error Report

The detailed open-LED error report can be read out immediately after global error mode has been run. SDI must be 1 for the first device.

Figure 14. Detailed Open-LED Error Report Timing Diagram



Detailed Open-LED Error Report Example

Consider a case where three AS1113s are cascaded in one chain. A 1 indicates a LED is on, a 0 indicates a LED is off, and an X indicates an open LED. The open-LED test is only applied to LEDs that are turned on. This test is used with a test pattern where all LEDs are on at test time.

IC1:[11111111111111] IC2:[111XX11111111X11] IC3:[111111111111111]

IC2 has three open LEDs switched on due to input. 3*16 clock cycles are needed to write the entire error code out. The detailed error report would look like this:



Comparing this report with the input data indicates that IC2 is the device with two open LEDs at position 4 and 5 and one open LED at position 14. For such a test it is recommended to enter low-current diagnostic mode first (see Low-Current Diagnostic Mode on page 15) to reduce screen flickering.

This test can be used also on-the-fly without using an all 1s test pattern (see Figure 18 on page 17).

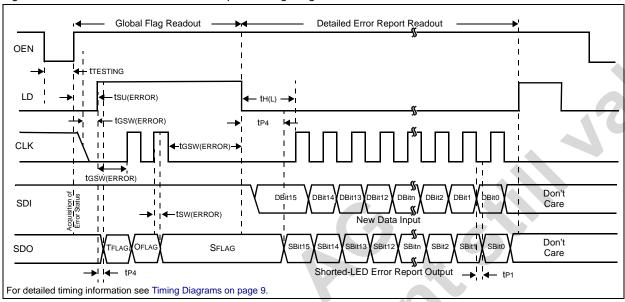
Note: In an actual report there are no spaces in the output. LEDs turned off during test time cannot be tested and will show a logic 1 in the detailed error report.



Detailed Shorted-LED Error Report

The detailed shorted-LED error report can be read out immediately after global error mode has been run (see Global Error Mode on page 11). SDI must be 1 for the first device.

Figure 15. Detailed Shorted-LED Error Report Timing Diagram



Detailed Shorted-LED Error Report Example

Consider a case where three AS1113s are cascaded in one chain. A 1 indicates a LED is on, a 0 indicates a LED is off, and an X indicates a shorted LED. This test is used on-the-fly.

IC1:[11111XX11111111] IC2:[111111111111111] IC3:[X100011111111111]

IC1 has two shorted LEDs which are switched on, IC3 has one shorted LED switched off due to input. 3*16 clock cycles are needed to write the entire error code out. The detailed error report would look like this:



Showing IC1 as the device with two shorted LEDs at position 6 and 7, and IC3 with one shorted LED at position 1. The shorted LED at position 1 of IC3 cannot be detected, since LEDs turned off at test time are not tested and will show a logic "1" at the detailed error report. To test all LEDs this test should be run with an all 1s test pattern. For a test with an all on test pattern, low-current diagnostic mode should be entered first to reduce on-screen flickering.

Note: In an actual report there are no spaces in the output. LEDs turned off during test time cannot be tested and will show a logic 1 in the detailed error report.

Low-Current Diagnostic Mode

To run the open- or shorted-LED test, a test pattern must be used that will turn on each LED to be tested. This test pattern will cause a short flicker on the screen while the test is being performed. The low-current diagnostic mode can be initiated prior to running a detailed error report to reduce this on-screen flickering.

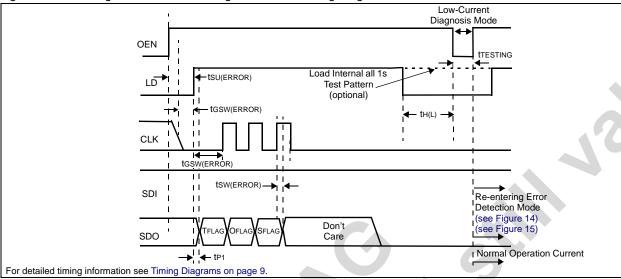
Note: Normally, displays using such a diagnostic mode require additional cables, resistors, and other components to reduce the current. The AS1113 has this current-reduction capability built-in, thereby minimizing the number of external components required.

Low-current diagnostic mode can be initiated via 3 clock pulses during error-detection mode. After the falling edge of LD, a test pattern displaying all 1s can be written to the shift register which will be used for the next error-detection test.



On the next falling edge of OEN, current is reduced to ILC. With the next rising edge of OEN the current will immediately increase to normal levels and the detailed error report can be read out entering error-detection mode.

Figure 16. Switching into Low-Current Diagnostic Mode Timing Diagram



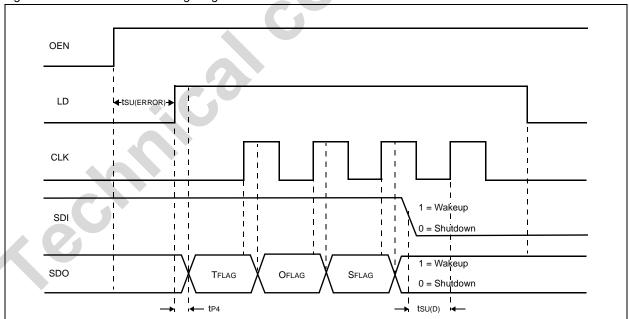
Shutdown Mode

The AS1113 features a shutdown mode which can be entered via 4 clock pulses during error-detection mode. To enable the shutdown mode a 0 must be placed at SDI after the rising edge of the 3rd clock pulse.

To disable shutdown mode a 1 must be placed at SDI after the 3rd clock pulse. The shutdown/wakeup information will be latched through if multiple AS1113 devices are in a chain. At the rising edge of the 4th clock pulse the shutdown bit will be read out and the AS1113 will shutdown or wakeup.

Note: In shutdown mode the supply current drops down to <10 μ A.

Figure 17. Shutdown Mode Timing Diagram





9 Application Information

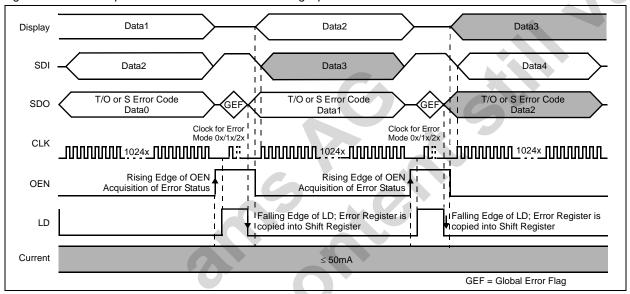
Error Detection

The AS1113 features two types of error detection. The error detection can be used on-the-fly, for active LEDs, without any delay, or by entering into low-current diagnosis mode.

Error Detection On-The-Fly

Error detection on-the-fly will output the status of active LEDs during operation. Without choosing an error mode this will output the temperature flag at every input/output cycle. Triggering one clock pulse for open or two clock pulses for short detection during error detection mode outputs the detailed open- or short-error report with the next input/output cycle (see Figure 18). LEDs turned off at test time are not tested and will show a logic "1" at the detailed error report.

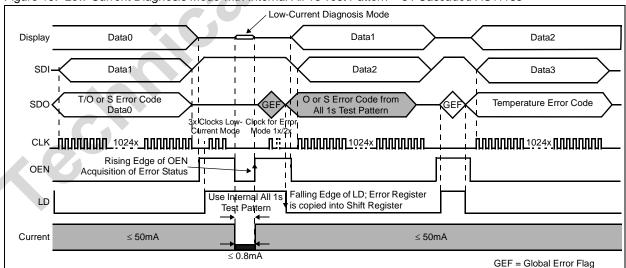
Figure 18. Normal Operation with Error Detection During Operation – 64 Cascaded AS1113s



Error Detection with Low-Current Diagnosis Mode

This unique feature of the AS1113 uses an internal all 1s test pattern for a flicker free diagnosis of all LEDs. This error detection mode can be started at the end of each input cycle (see Figure 19).

Figure 19. Low-Current Diagnosis Mode with Internal All 1s Test Pattern - 64 Cascaded AS1113s





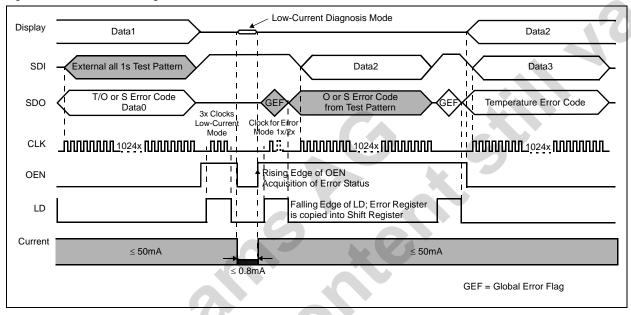
The last pattern written into the shift register will be saved before starting low-current diagnosis mode and can be displayed immediately after the test has been performed.

Low-current diagnostic mode is started with 3 clock pulses during error detection mode. Then OEN should be enabled for $\ge 2\mu s$ for testing. With the rising edge of OEN the LED test is stopped, and while LD is high the desired error mode can be selected with the corresponding clock pulses. After LD and OEN go low again the previously saved pattern can be displayed at the outputs.

With the next data input the detailed error code will be clocked out at pin SDO.

Note: See Figure 20 for use of an external test pattern.

Figure 20. Low-Current Diagnosis Mode with External Test Pattern – 64 Cascaded AS1113s

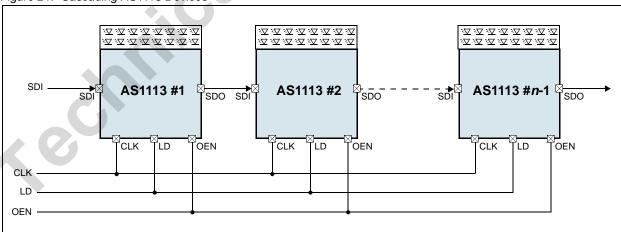


Cascading Devices

To cascade multiple AS1113 devices, pin SDO must be connected to pin SDI of the next AS1113 (see Figure 21). At each rising edge of CLK the LSB of the shift register will be written into the shift register SDI of the next AS1113 in the chain.

Note: When n^* AS1113 devices are in one chain, n^* 16 clock pulses are needed to latch-in the input data.

Figure 21. Cascading AS1113 Devices





Constant Current

In LED display applications, the AS1113 provides virtually no current variations from channel-to-channel and from AS1113-to-AS1113. This is mostly due to 2 factors:

- While Iout ≥ 10mA, the maximum current skew is less than ±3% between channels and less than ±6% between AS1113 devices.
- In the saturation region, the characteristic curve of the output stage is flat (see Figure 5 on page 7). Thus, the output current can be kept constant regardless of the variations of LED forward voltages (VF).

Adjusting Output Current

The AS1113 scales up the reference current (IREF) set by external resistor (REXT) to sink a current (IOUT) at each output port. As shown in Figure 3 on page 7 the output current in the saturation region is extremely flat so that it is possible to define it as target current (IOUT TARGET). IOUT TARGET can be calculated by:

$$VREXT = 1.253V (EQ 1)$$

$$IREF = VREXT/REXT$$
 (if the other end of REXT is connected to ground) (EQ 2)

IOUT TARGET =
$$IREF^*15 = (1.253V/Rext)^*15$$
 (EQ 3)

Where:

REXT is the resistance of the external resistor connected to pin REXT.

VREXT is the voltage on pin REXT.

The magnitude of current (as a function of REXT) is around 50.52mA at 372 Ω and 25.26mA at 744 Ω . Figure 3 on page 7 shows the relationship curve between the lout target of each channel and the corresponding external resistor (REXT).

Package Power Dissipation

The maximum allowable package power dissipation (PD) is determined as:

$$PD(MAX) = (TJ-TAMB)/RTH(J-A)$$
 (EQ 4)

When 16 output channels are turned on simultaneously, the actual package power dissipation is:

$$PD(ACT) = (IDD*VDD) + (IOUT*Duty*VDS*16)$$
 (EQ 5)

Therefore, to keep PD(ACT) ≤ PD(MAX), the maximum allowed output current as a function of duty cycle is:

$$IOUT = \{[(T_J-T_{AMB})/R_{TH(J-A)}]-(IDD*V_{DD})\}/V_{DS}/D_{Uty}/16$$
 (EQ 6)

Where:

 $T_{J} = 150^{\circ}C$

Delayed Outputs

The AS1113 has graduated delay circuits between outputs. These delay circuits can be found between OUTNn and constant current block.

The fixed delay time is 20 ns (typ) where OUTN0 has no delay, OUTN1 has 20ns delay, OUTN2 has 40ns delay ... OUTN15 has 300ns delay. This delay prevents large inrush currents, which reduce power supply bypass capacitor requirements when the outputs turn on (see Figure 10 on page 10)

Switching-Noise Reduction

LED drivers are frequently used in switch-mode applications which normally exhibit switching noise due to parasitic inductance on the PCB.

Load Supply Voltage

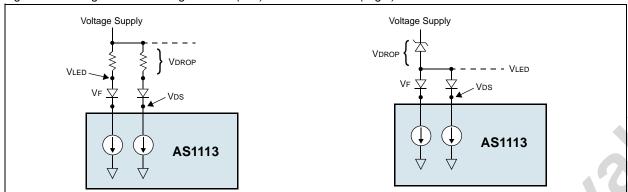
Considering the package power dissipation limits (see EQ 4:6), the AS1113 should be operated within the range of VDS = 0.4 to 1.0V.

For example, if VLED is higher than 5V, VDS may be so high that PD(ACT) > PD(MAX) where VDS = VLED - VF. In this case, the lowest possible supply voltage or a voltage reducer (VDROP) should be used. The voltage reducer allows VDS = (VLED - VF) - VDROP.

Note: Resistors or zener diodes can be used as a voltage reducer as shown in Figure 22.



Figure 22. Voltage Reducer using Resistor (Left) and Zener Diode (Right)

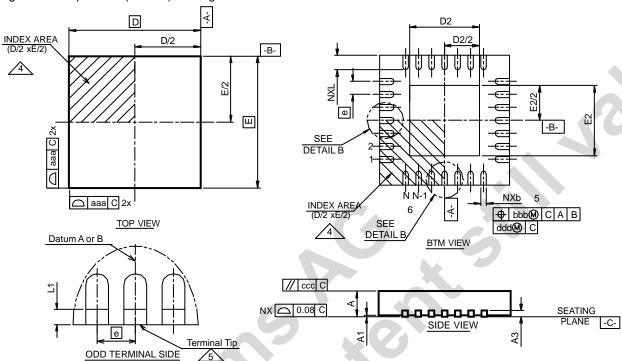




10 Package Drawings and Markings

The AS1113 is available in a 28-pin QFN (5x5mm) package and a 24-pin SSOP package.

Figure 23. 28-pin QFN (5x5mm) Packagee



Symbol	Min	Тур	Max	Notes
Α	0.70	0.75	0.80	1, 2
A1	0.00	0.02	0.05	1, 2
A3		0.20 REF		1, 2
L	0.45	0.55	0.65	1, 2
L1	0.03		0.15	1, 2
aaa		0.15		1, 2
bbb		0.10		1, 2
ccc		0.10	5	1, 2
ddd		0.05		1, 2
eee		0.08		1, 2
999		0.10		1, 2

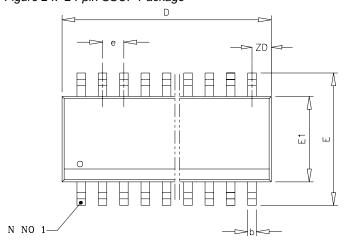
Symbol	Min	Тур	Max	Notes
D BSC		5.00		1, 2
E BSC		5.00		1, 2
D2	3.00	3.15	3.25	1, 2
E2	3.00	3.15	3.25	1, 2
K	0.20			1, 2
b	0.18	0.25	0.30	1, 2, 5
е		0.50		
N		28		1, 2
ND		7		1, 2, 5
NE		7		1, 2, 5

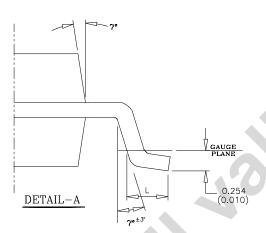
Notes: Unilateral coplanarity zone applies to the exposed heat sink slug as well as the terminals.

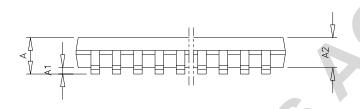
- 1. Dimensioning and tolerancing conform to ASME Y14.5M-1994.
- 2. All dimensions are in millimeters; angles in degrees.
- 3. N is the total number of terminals.
- 4. The terminal #1 identifier and terminal numbering convention shall conform to *JEDEC 95 SPP-012*. Details of terminal #1 identifier are optional but must be located within the zone indicated. The terminal #1 identifier may be either a mold or marked feature.
- 5. Dimension b applies to metallized terminal and is measured between 0.15 and 0.30mm from terminal tip. If one end of the terminal has the optional radius, the b dimension should not be measured in that radius area.
- 6. Dimensions ND and NE refer to the number of terminals on each D and E side, respectively.

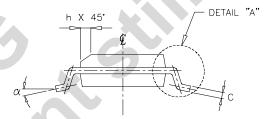


Figure 24. 24-pin SSOP Package









Symbol	Min	Max
Α	1.35	1.75
A1	0.10	0.25
A2	1.37	1.57
b	0.20	0.30
С	0.19	0.25
D	8.55	8.74
Е	5.79	6.20
E1	3.81	3.99
е	0.635	BSC
h	0.22	0.49
L	0.40	1.27
θ	00	80



11 Ordering Information

The device is available as the standard products shown in Table 9.

Table 9. Ordering Information

Ordering Code	Description	Delivery Form	Package
AS1113-BSSU	50mA, 16-Channel LED Driver with Diagnostics	Tubes	24-pin SSOP
AS1113-BSST	50mA, 16-Channel LED Driver with Diagnostics	Tape and Reel	24-pin SSOP
AS1113-BQFR	50mA, 16-Channel LED Driver with Diagnostics	Tray	28-pin QFN (5x5mm)
AS1113-BQFT	50mA, 16-Channel LED Driver with Diagnostics	Tape and Reel	28-pin QFN (5x5mm)

Note: All products are RoHS compliant and Pb-free.

Buy our products or get free samples online at ICdirect: http://www.austriamicrosystems.com/ICdirect

For further information and requests, please contact us mailto:sales@austriamicrosystems.com or find your local distributor at http://www.austriamicrosystems.com/distributor





Copyrights

Copyright © 1997-2009, austriamicrosystems AG, Tobelbaderstrasse 30, 8141 Unterpremstaetten, Austria-Europe. Trademarks Registered ®. All rights reserved. The material herein may not be reproduced, adapted, merged, translated, stored, or used without the prior written consent of the copyright owner.

All products and companies mentioned are trademarks or registered trademarks of their respective companies.

Disclaimer

Devices sold by austriamicrosystems AG are covered by the warranty and patent indemnification provisions appearing in its Term of Sale. austriamicrosystems AG makes no warranty, express, statutory, implied, or by description regarding the information set forth herein or regarding the freedom of the described devices from patent infringement. austriamicrosystems AG reserves the right to change specifications and prices at any time and without notice. Therefore, prior to designing this product into a system, it is necessary to check with austriamicrosystems AG for current information. This product is intended for use in normal commercial applications. Applications requiring extended temperature range, unusual environmental requirements, or high reliability applications, such as military, medical life-support or life-sustaining equipment are specifically not recommended without additional processing by austriamicrosystems AG for each application. For shipments of less than 100 parts the manufacturing flow might show deviations from the standard production flow, such as test flow or test location.

The information furnished here by austriamicrosystems AG is believed to be correct and accurate. However, austriamicrosystems AG shall not be liable to recipient or any third party for any damages, including but not limited to personal injury, property damage, loss of profits, loss of use, interruption of business or indirect, special, incidental or consequential damages, of any kind, in connection with or arising out of the furnishing, performance or use of the technical data herein. No obligation or liability to recipient or any third party shall arise or flow out of austriamicrosystems AG rendering of technical or other services.



Contact Information

Headquarters austriamicrosystems AG Tobelbaderstrasse 30 A-8141 Unterpremstaetten, Austria

Tel: +43 (0) 3136 500 0 Fax: +43 (0) 3136 525 01

For Sales Offices, Distributors and Representatives, please visit:

http://www.austriamicrosystems.com/contact